

RoHS Compliant Product  
A suffix of "C" specifies halogen & lead-free

## FEATURES

- High Surge Current Capability
- Saves Space on Printed Circuit Boards
- Glass Passivated Structure

## MECHANICAL DATA

- Terminals: Solderable per MIL-STD-750, Method 2026
- Case: TFS
- Mounting Position: Any

## MARKING

Part Number	Marking	Part Number	Marking
TF201S-C	ABS201	TF206S-C	ABS206
TF202S-C	ABS202	TF208S-C	ABS208
TF204S-C	ABS204	TF210S-C	ABS210

## PACKAGE INFORMATION

Package	MPQ	Leader Size
TFS	5K	13 inch

## ORDER INFORMATION

Part Number	Type
TF201S-C~TF210S-C	Lead (Pb)-free and Halogen-free

## MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Rating 25°C ambient temperature unless otherwise specified. Single phase half wave, 60Hz, resistive or inductive load.  
For capacitive load, de-rate current by 20%.)

Parameter	Symbol	Part Number						Unit
		TF 201S-C	TF 202S-C	TF 204S-C	TF 206S-C	TF 208S-C	TF 210S-C	
Maximum Recurrent Peak Reverse Voltage	$V_{RRM}$	100	200	400	600	800	1000	V
Maximum RMS Voltage	$V_{RMS}$	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	$V_{DC}$	100	200	400	600	800	1000	V
Maximum Average Forward Current $T_L=110^\circ\text{C}$	$I_{F(AV)}$	2						A
Peak Forward Surge Current, 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	$I_{FSM}$	50						A
Maximum Instantaneous Forward Voltage @ $I_F=1\text{A}$	$V_F$	1						V
Maximum DC Reverse Current at Rated DC Blocking Voltage	$I_R$	5						$\mu\text{A}$
		500						
Typical Junction Capacitance <sup>1</sup>	$C_J$	25						pF
Thermal Resistance Junction-Ambient <sup>2</sup>	$R_{\theta JA}$	80						$^\circ\text{C}/\text{W}$
Thermal Resistance Junction-Lead <sup>2</sup>	$R_{\theta JL}$	16						$^\circ\text{C}$
Operating & Storage Temperature Range	$T_J, T_{STG}$	-55~150						$^\circ\text{C}$

Notes:

1. Measured at 1MHz and applied reverse voltage of 4V D.C.
2. Mounted on glass epoxy PC board with 4 x 2.54mm<sup>2</sup> copper pad.

## RATINGS AND CHARACTERISTIC CURVES

Fig.1 Average Rectified Output Current Derating Curve

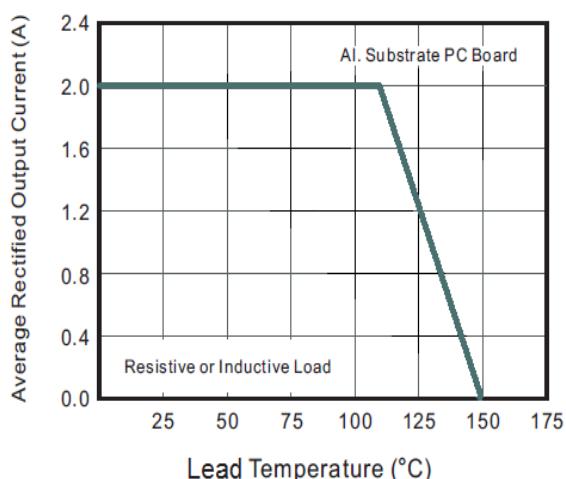


Fig.2 Typical Reverse Characteristics

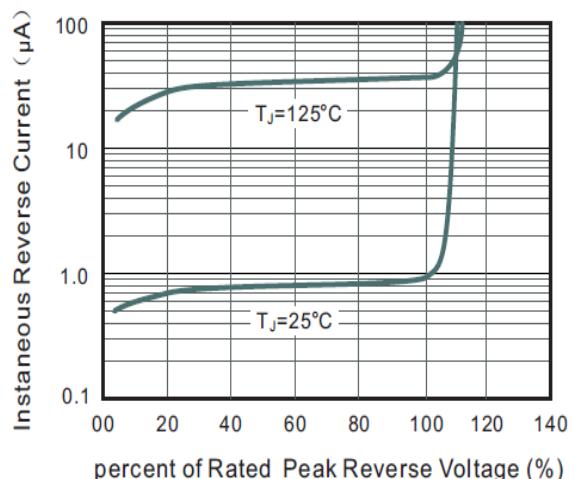


Fig.3 Typical Instantaneous Forward Characteristics

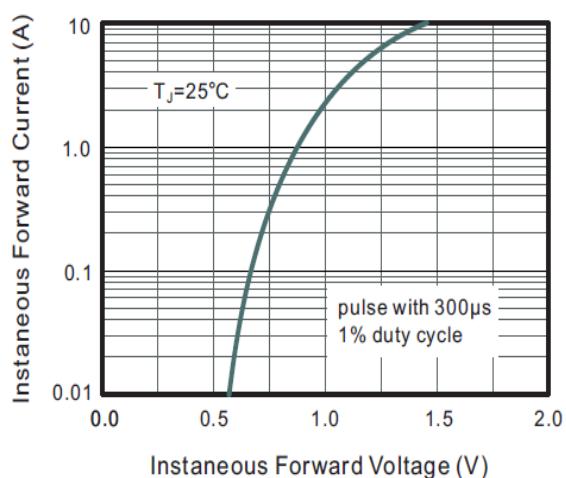


Fig.4 Typical Junction Capacitance

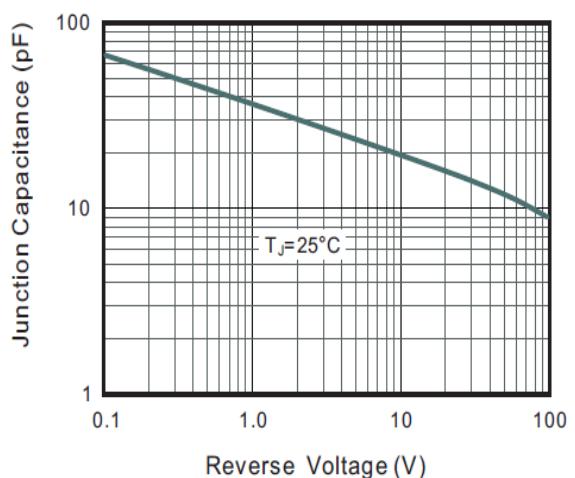


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

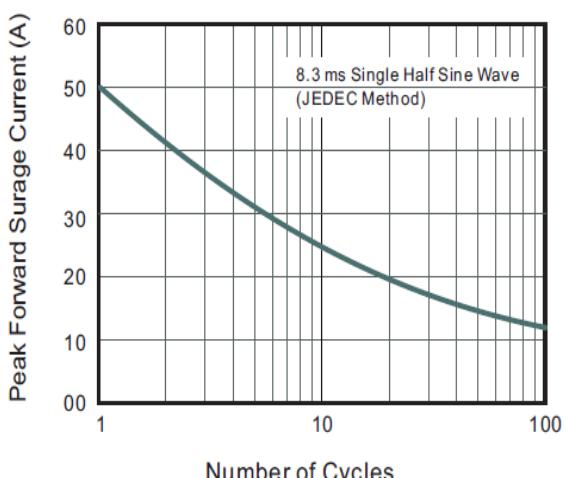


Fig.6 Mounting Pad Layout

